MEI Form -1.2, (July 1, 2005)

Docket No.

Docket No.				
			Y FOR U.S. PATENT API	=
As a below named invenext to my name; and I believe and joint inventor (if plural inventhe invention entitled:	that I am the origi	inal, first and sole in		d below) or an original, firs
Title: SEMICONDUCT	OR DEVICE AND I	METHOD FOR FAB	RICATING THE SAME	
the attached specification.	or		the specification of which is atta	•
the specification in the Ap	nlication No.		filed on	
and with amendments file	d on		filed on(if applicable	, e) or
the specification in Internal	ational Application	No. PCT/ JP2005/0	009268	
filed May 20, 20	005	_and as amended or	009268 n(if a	applicable).
as amended by any amendmen I acknowledge my duty patentability as defined in Title 3	t(s) referred to about to disclose to the 37, Code of Federa priority benefits unentor's certificate, of America, li	ve. U.S. Patent and Tra Il Regulations, §1.56 Inder Title 35, United or §365(a) of any Poisted below, and have	States Code, §119 (a-d), §172 CT international application white also identified below any fore	nown to me to be material to 2, or \$365(b) of any foreign ich designated at least one eign application for patent o
COUNTRY	APPLIC	ATION NO.	DATE OF FILING	PRIORITY CLAIMED
JAPAN	2004-	-165361	June 3 ,2004	YES
·				
□ Additional foreign or internation  I hereby claim the ber listed below.			supplemental priority sheet atta	
Number		(Day/Month/Year Filed)		

□ Additional U.S. provisional application numbers are listed on a supplemental priority sheet attached hereto.

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I hereby claim the benefit under Title 35, United States Code §120 of any United States application(s), or §365(C) of any PCT international application designating the United States of America, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT international application in the manner provided by the first paragraph of Title 35, United States Code §112, I acknowledge the duty to disclose information material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application.

APPLICATION NO.	U.S. FILING DATE	STATUS: PATENTED, PENDING, ABANDONED

□ Additional U.S. or international application numbers are listed on a supplemental priority sheet attached hereto.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the attorneys and agents associated with U.S. Patent and Trademark Office Customer Number identified bellow to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith, and direct that all correspondence be addressed to that customer number.

I hereby authorize the U.S. attorneys and agents associated with the customer number to accept and follow instructions from Matsushita Electric Industrial Co., Ltd., and any affiliated or subsidiary company thereof, received via their corporate representatives and/or their foreign patent attorneys or agents, if any, as to any action to be taken in the U.S. Patent and Trademark Office regarding this application without direct communication between the U.S. attorneys or agents and myself.

Direct Correspondence to:		
	CUSTOMER NUMBER 53080	

I further declare that all statements made herein of my own knowledge are true, and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

		2006/1/18		
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## Docket No.

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(If there are more than	seven inventors, pleas	e add a copy of this page for	identification and signatu	re for the additi	onal
inventors)					
he above application may be m	ore particularly identified	d as follows:			
.S. Application No.		Filing Date			